CRYSTAL OSCILLATOR

PROGRAMMABLE

SG-8002JF/CA series

•Frequency range : 1 MHz to 125 MHz •Supply voltage : 3.3 V / 5.0 V

•Function : Output enable(OE) or Standby($\overline{\text{ST}}$)
•External dimensions : 7.0 × 5.0 × 1.4 mm ···SG-8002CA
•Pin compatible with ceramic package crystal oscillator (7 × 5)

: SG-8002JF

Short mass production lead time by PLL technology.

•SG-Writer available to purchase.

Please contact Epson Toyocom or local sales representative.





Product Number (please contact us) SG-8002JF: Q3308JFx1xxxx00 SG-8002CA: Q3309CAx0xxxx00





Actual size

SG-8002JF SG-8002CA

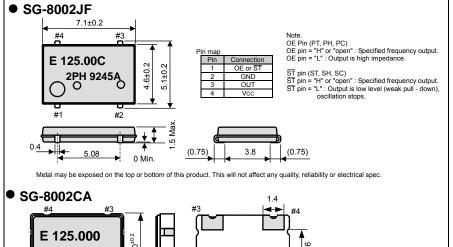
Specifications (characteristics)

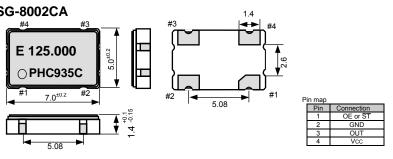
Item		Symbol	Specifications *2			Demode
			PT/ST	PH/SH	PC / SC	Remarks
Output frequency range		fo	1 MHz to 125 MHz			Vcc=4.5 V to 5.5 V
			_		1 MHz to 125 MHz	Vcc=3.0 V to 3.6 V
			_		1 MHz to 66.7 MHz	Vcc=2.7 V to 3.6 V
Supply voltage		Vcc	4.5 V to 5.5 V 2.7 V to 3.6 V		2.7 V to 3.6 V	
Temperature range	Storage temperature	T_stg	-55 °C to +125 °C			Store as bare product after unpacking
	Operating temperature	T_use	-20 °C to +70 °C (-40 °C to +85 °C)		-40 °C to +85 °C	Refer to "Outline specifications" (Frequency range)
Frequency tolerance		f_tol	B: ±50 × 10 ⁻⁶ ,C: ±100 × 10 ⁻⁶			-20 °C to +70 °C
			M: ±100 × 10 ⁻⁶			-40 °C to +85 °C *3
Current consumption		Icc	45 mA Max. 28 mA Max.		No load condition, Max. frequency range	
Disable current		I_dis	30 mA Max. 16 mA Max.		OE=GND(PT,PH,PC)	
Stand-by current		I_std	50 μA Max.		\overline{ST} =GND(ST,SH,SC)	
Symmetry*1		SYM	— 40 % to 60 %		CMOS load:50 % Vcc level, Max. load condition	
			40 % to 60 %		TTL load: 1.4 V level, Max. load condition	
High output voltage		Vон	Vcc-0.4 V Min.		Iон=-16 mA(PT / ST,PH / SH),-8 mA(PC / SC)	
Low output voltage		Vol	0.4 V Max.		IoL=16 mA(PT / ST,PH / SH), 8 mA(PC / SC)	
Output load condition (TTL) *1		L_TTL	5TTL Max. —		f₀≤90 MHz,Max. supply voltage	
Output load condition (CMOS) *1		L_CMOS	15 pF Max.	15 pF Max. (CA:25 pF Max.)	15 pF Max.	Max. frequency and Max. supply voltage
Output enable / disable		VIH	2.0 V Min.		70 % Vcc Min.	ST terminal or OE terminal
input voltage		VIL	0.8 V Max. 20		20 % Vcc Max.	SI terminal of OE terminal
Rise time / Fall time *1		t r / t f	3 ns M		Max.	CMOS load: 20 % Vcc to 80 % Vcc level
			4 ns Max.		TTL load: 0.4 V to 2.4 V level	
Start-up time		t_str	10 ms Max.		Time at minimum supply voltage to be 0 s	
Frequency aging		f_aging	$\pm 5 \times 10^{-6}$ / year Max.		+25 °C, Vcc=5.0 V/ 3.3 V (PC / SC) First year	

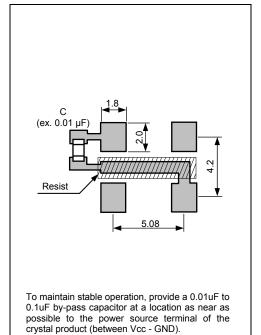
- *1 Operating temperature (-40 °C to +85 °C), the available frequency, symmetry and output load conditions, please refer to "Outline specifications" page.
- *2 PLL-PLL connection & Jitter specification, please refer to "Jitter specifications and characteristics chart" page.
- *3 PT / ST and PH / SH for "M" tolerance will be available up to 55 MHz. (JF:40 MHz) Checking possible by the Frequency Checking Program.

External dimensions

(Unit:mm) Footprint (Recommended) (Unit:mm)







"QMEMS" EPSON TOYOCOM

In order to meet customer needs in a rapidly advancing digital, broadband and ubiquitous society, we are committed to offering products that are one step ahead of the market and a rank above the rest in quality. To achieve our goals, we follow a "3D (three device) strategy" designed to drive both horizontal and vertical growth. We will to grow our three device categories of "Timing Devices", "Sensing Devices" and "Optical Devices", and expand vertical growth through a combination of products from these categories.

A Quartz MEMS is any high added value quartz device that exploits the characteristics of quartz crystal material but that is produced using MEMS (micro-electro-mechanical system) processing technology.

Market needs are advancing faster than previously imagined toward smaller, more stable crystal products, but we will stay ahead of the curve by rolling out products that exceed market speed and quality requirements. We want to further accelerate the 3D strategy by QMEMS.

Quartz devices have become crucial in the network environment where products are increasingly intended for broadband, ubiquitous applications

and where various types of terminals can transfer information almost immediately via LAN and WAN on a global scale. Epson Toyocom Corporation addresses every single aspect within a network environment. The new corporation offers "Digital Convergence" solutions to problems arising with products for consumer use, such as, core network systems and automotive systems.



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PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Epson Toyocom, all environmental initiatives operate under the Plan-Do-Check-Action(PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites,in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs,

Epson Toyocom made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired ISO/TS 16949 certification that is requested strongly by major automotive manufacturers as standard.

ISO/TS16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

Explanation of the mark that are using it for the catalog



►Pb free.



- ► Complies with EU RoHS directive.
 - *About the products without the Pb-free mark.

 Contains Pb in products exempted by EU RoHS directive.

 (Contains Pb in sealing glass, high melting temperature type solder or other.)



▶ The products have been designed for high reliability applications such as Automotive.

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